

## **Current Report No. 2/2017**

Date of preparation: 04.04.2017

### **Subject: Establishing a Bond Issue Program and entering into a bond issue program agreement**

The Management Board of MLP GROUP S.A. ("Company") reports that on 4 April 2017 it adopted resolution no. 1/04/2017 on establishing a bond issue program under which, on 4 April 2017, a bond issue program agreement was entered into by and between the Company and Bank Polska Kasa Opieki S.A. acting as Arranger, Issue Agent, Payment Agent, Calculation Agent, Dealer, Custodian and Bookrunner, with Pekao Investment Banking S.A. acting as Arranger, Technical Agent and Dealer ("Program Agreement").

The Program Agreement makes it possible to issue bonds in series offered under private placements, pursuant to Article 33 Item 2 of the Act on Bonds of 15 January 2015.

In accordance with the Program Agreement, the bond issue program provides for issue of the Company's bonds in multiple series according to the rules set out in the Agreement up to EUR 50,000,000 forming the maximum permissible total value of outstanding bonds.

The bonds issued under the Program Agreement will be unsecured bonds entitling bondholders to receive benefits only in the form of cash. The bonds may be floated on the alternative trading system operated by the Warsaw Stock Exchange or BondSpot S.A.

The maturity of the bonds issued under the Program will not exceed 10 years. The nominal value of each bond issued under the Program will be EUR 1,000 or a multiple thereof. The Program Agreement was concluded for an indefinite term.

The detailed terms and conditions for issuing the various series of the bonds will be specified separately in the pertinent issue documents.

*General legal basis: Article 17 Sec. 1 MAR, confidential information.*